## SN54159, SN74159 4-LINE TO 16-LINE DECODERS/DEMULTIPLEXERS WITH OPEN-COLLECTOR OUTPUTS

#### **SDLS059**

DECEMBER 1972 - REVISED MARCH 1988

- Open-Collector Outputs for Interfacing with MOS or Memory Decoders/Drivers
- Decodes 4 Binary-Coded Inputs into One of 16 Mutually Exclusive Outputs
- Performs the Demultiplexing Function by Distributing Data from One Input Line to Any One of 16 Outputs
- Typical Average Propagation Delay Times:
  24 ns through 3 levels of Logic
  19 ns from Strobe Input
- Output Off-State Current is Less Than 50 μA
- Fully Compatible with Most TTL and MSI Circuits

#### SN54159 . . . J OR W PACKAGE SN74159 ... N PACKAGE (TOP VIEW) U24∏ VCC 1 🗆 2 23 A 22 B 2 🗍 3 21 C 3 □4 20 D 19 G2 5 18∐ G1 ñ 17 15 8 7 14 16 9 15 13 10 14 12 11 GND ∏12 13 11

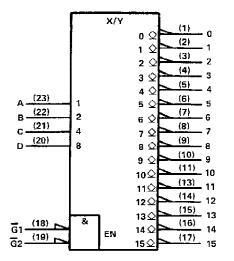
### description

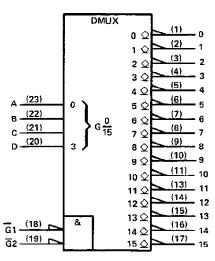
Each of these monolithic, 4-line-to-16 line decoders utilizes TTL circuitry to decode four binary-coded inputs into one of sixteen mutually exclusive open-collector outputs when both the strobe inputs,  $\overline{G}1$  and  $\overline{G}2$ , are low. The demultiplexing function is performed by using the 4 input lines to address the output line, passing data from one of the strobe inputs with the other strobe input low. When either strobe input is high, all outputs are high. These demultiplexers are ideally suited for implementing MOS memory decoding or for interfacing with discrete memory address drivers. For ultra-high-speed applications, the SN54S138/SN74S138 or SN54S139/SN74S139 is recommended.

These circuits are fully compatible for use with most other TTL circuits. Input clamping diodes are provided to minimize transmission-line effects and thereby simplify system design. Input buffers are used to lower the fan-in requirement to only one normalized Series 54/74 load. A fan-out to 10 normalized Series 54/74 loads in the low-level state is available from each of the sixteen outputs. Typical power dissipation is 170 mW.

The SN54159 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C; the SN74159 is characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.

### logic symbols (alternatives)†





<sup>†</sup>These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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# SN54159, SN74159 4-LINE TO 16-LINE DECODERS/DEMULTIPLEXERS WITH OPEN-COLLECTOR OUTPUTS

|    |    |     |     |   |    |   |     |   | FUN      | CTIO | V TAE | LE |     |      |   |          |    |    |    |    |     |
|----|----|-----|-----|---|----|---|-----|---|----------|------|-------|----|-----|------|---|----------|----|----|----|----|-----|
|    |    | INP | UTS |   |    |   |     |   |          |      |       |    | OUT | PUTS |   |          |    |    | •  |    |     |
| Ğ1 | Ğ2 | D   | С   | В | Д  | 0 | 1   | 2 | 3        | 4    | 5     | 6  | 7   | 8    | 9 | 10       | 11 | 12 | 13 | 14 | 15  |
| L  | L  | L   | L   | L | Ļ  | L | Н   | Ħ | Н        | Н    | Н     | Н  | н   | Н    | Н | Н        | Н  | Н  | Н  | н  | н   |
| L  | L  | L   | L   | L | Н  | н | L   | Н | н        | Н    | Н     | Н  | Н   | Н    | Н | Н        | н  | Н  | H  | Н  | н   |
| L  | L  | L   | L   | н | Ł  | н | H   | L | Н        | Н    | н     | н  | н   | н    | н | н        | H  | н  | Н  | Н  | н   |
| L  | L  | L   | L   | Н | Н  | н | H   | Н | L        | Н    | Н     | Н  | н   | Н    | н | н        | н  | н  | н  | Н  | н   |
| L  | L  | L   | Н   | L | L  | н | Н   | Н | н        | L    | Н     | н  | н   | н    | н | Н        | H  | н  | н  | н  | н   |
| Ļ  | L  | L   | Н   | L | Н  | н | Н   | Н | H        | Н    | L     | Н  | H   | Н    | H | H        | H  | н  | н  | Н  | н   |
| L  | L  | L   | Н   | Н | L  | Н | Н   | Н | Н        | н    | Н     | L  | н   | Н    | н | н        | Н  | Н  | н  | н  | н   |
| L  | L  | L   | н   | Н | ٠н | н | н   | Н | н        | Н    | н     | н  | L   | Н    | н | Н        | Н  | н  | Н  | Н  | -н  |
| L  | L  | H   | L   | L | L  | H | Н   | Н | H        | Н    | н     | Н  | H   | L    | Н | H        | н  | н  | Н  | н  | н   |
| L  | L  | н   | L   | L | н  | н | Н   | н | H        | н    | H     | н  | н   | н    | L | Н        | Н  | Н  | Н  | Н  | н   |
| L  | L  | H   | L   | Н | L  | Н | Н   | Н | H        | H    | Н     | н  | н   | H    | H | L        | н  | Н  | н  | Н  | - н |
| L  | L  | H   | L   | Н | н  | Н | Н   | Н | н        | н    | H     | н  | н   | Н    | н | Н        | L  | Н  | н  | н  | н   |
| L  | Ł  | H   | Н   | L | Ļ  | Н | Н   | Н | Н        | Ħ    | Н     | H  | Н   | Н    | Н | Н        | Н  | L  | Н  | H  | н   |
| L  | L  | H   | H   | L | н  | н | Н   | н | H        | н    | н     | H  | н   | Н    | н | Н        | Н  | Н  | L  | Н  | н   |
| L. | i. | н   | Н   | Н | L  | н | Н   | Н | Н        | Н    | н     | Н  | Н   | Н    | н | н        | Н  | Н  | н  | L  | н   |
| L  | Ł  | н   | Н   | Н | Н  | н | Н   | Н | Н        | Н    | Н     | Н  | H   | Н    | н | Н        | Н  | Н  | Н  | н  | L,  |
| L  | н  | ×   | ×   | × | ×  | н | Н   | н | Н        | H    | Н     | Н  | Н   | Н    | Н | H        | Н  | Н  | н  | н  | н   |
| н  | L  | ×   | Х   | Х | Х  | н | Н   | H | Н        | Н    | н     | Н  | Н   | Н    | Н | Н        | Н  | Н  | Н  | Н  | н   |
| Н  | н  | Х   | Х   | Х | X  | н | _н_ | Н | <u>H</u> | H    | Н     | Н  | Н   | н    | н | <u> </u> | н  | н  | н  | н  | Н   |

H = high level, L = low level, X = irrelevant

## logic diagram

Same as SN54154, SN74154.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) |  |
|----------------------------------|--|
| Input voltage                    |  |
|                                  |  |
|                                  |  |
| SN74159 Circuits                 |  |
| Storage temperature range        |  |

NOTE 1: Voltage values are with respect to network ground terminal,

### recommended operating conditions

|  |      | SN5415 | 9   |      | SN7415 | 9    |      |
|--|------|--------|-----|------|--------|------|------|
|  | MIN  | NOM    | MAX | MIN  | NOM    | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub>                | 4.5  | 5      | 5.5 | 4.75 | 5      | 5.25 | V    |
| Low-level output current, IQL                  |      |        | 16  |      |        | 16   | mA   |
| Operating free-air temperature, T <sub>A</sub> | - 55 |        | 125 | 0    |        | 70   | ³c   |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|     | PARAMETER                              | TEST CONDITIONS <sup>†</sup>  | MIN | TYP | MAX  | UNIT |
|-----|--|---|-----|-----|------|------|
| VIH | High-level input voltage               |   | 2   |     |      | ν    |
| VIL | Low-level input voltage                |   |     |     | 0.8  | V    |
| VIK | Input clamp voltage                    | V <sub>CC</sub> = MIN, 1₁ = -12 mA  |     |     | -1.5 | V    |
| юн  | High-level output current              | V <sub>CC</sub> = MIN, V <sub>IH</sub> - 2 V,<br>V <sub>IL</sub> = 0.8 V, V <sub>OH</sub> = 5.5 V |     |     | 50   | μА   |
| VOL | Low-level output voltage               | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,<br>V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16 mA |     |     | 0.4  | ٧    |
| Н   | Input current at maximum input voltage | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V   |     |     | 1    | mΑ   |
| ПН  | High-level input current               | V <sub>CC</sub> = MAX, V <sub>1</sub> = 2.4 V   |     |     | 40   | μA   |
| ηL  | Low-level input current                | V <sub>CC</sub> = MAX, V <sub>1</sub> = 0.4 V   |     |     | -1.6 | mА   |
| Icc | Supply current                         | V <sub>CC</sub> = MAX, All inputs grounded  |     | 34  | 56   | mΑ   |

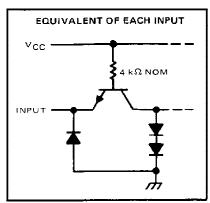
<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type,  $\ddagger$ AII typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_{A} = 25^{\circ}\text{C}$ .

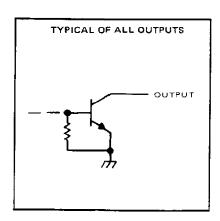
## switching characteristics, VCC = 5 V, TA = 25°C

|                  | PARAMETER   | TEST CONDITIONS                    | MIN | TYP | MAX | UNIT |
|------------------|---|------------------------------------|-----|-----|-----|------|
| <sup>t</sup> PLH | Propagation delay time, low-to-high-level output, from A, B, C, or D inputs through 3 levels of logic |                                    |     | 23  | 36  | ns   |
| †PHL             | Propagation delay time, high-to-low-level output, from A, B, C, or D inputs through 3 levels of logic | C 155 P 400 C. See Nov. 2          |     | 24  | 36  | ns   |
| ₹PLH             | Propagation delay time, low-to-high-level output, from either strobe input                            | CL + 15 pF, RL = 400 Ω, See Note 2 |     | 15  | 25  | ns   |
| ₹PH L            | Propagation delay time, high-to-low-level output, from either strobe input                            |                                    |     | 22  | 36  | ns   |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

### schematics of inputs and outputs





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### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | _  | kage<br>Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|----|-------------|-------------------------|------------------|------------------------------|
| SN74159N         | ACTIVE                | PDIP            | N                  | 24 | 15          | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-NC-NC-NC               |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

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**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

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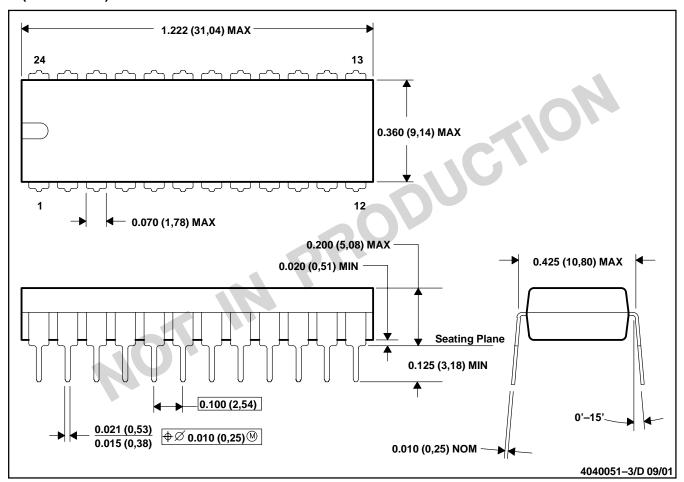
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## N (R-PDIP-T24)

### PLASTIC DUAL-IN-LINE



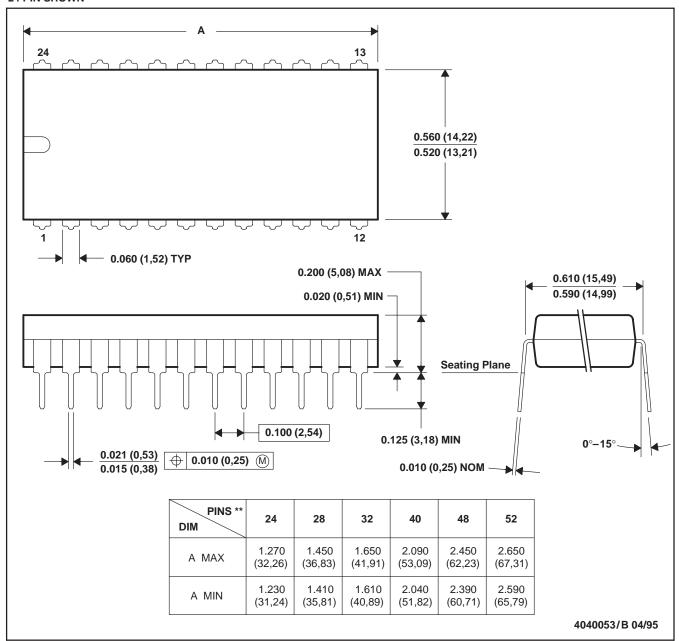
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-010

## N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

### 24 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-011
- D. Falls within JEDEC MS-015 (32 pin only)



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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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